

# LOCTITE ABLESTIK 3880

September 2015

## PRODUCT DESCRIPTION

LOCTITE ABLESTIK 3880 provides the following product characteristics:

<b>Technology</b>	Epoxy
<b>Chemical Type</b>	Epoxy
<b>Appearance (uncured)</b>	Silver paste <sup>LMS</sup>
<b>Appearance (cured)</b>	Silver solid <sup>LMS</sup>
<b>Components</b>	One component - requires no mixing
<b>Cure</b>	Heat cure
<b>Application</b>	Conductive adhesive
<b>Key Substrates</b>	Electronic components
<b>Other Application Areas</b>	Thermal conduction
<b>Dispense Method</b>	Syringe and Stencil print

LOCTITE ABLESTIK 3880 is designed for bonding of metals, ceramics, rubbers and plastics as used in electronic parts, where good adhesion combined with electrical and thermal conductivity is required. Typical applications include bonding surface mount devices to flexible or rigid substrates, bonding of semiconductor elements, joining EMI parts, bonding electrodes, lead wires or other connectors that require conductivity.

## TYPICAL PROPERTIES OF UNCURED MATERIAL

Specific Gravity @ 25 °C	2.4
Viscosity, Brookfield - RVT, 25 °C, mPa·s (cP):	
Spindle 14, speed 5 rpm	50,000 to 150,000 <sup>LMS</sup>
, with small sample adaptor	
VOC, ASTM D 3960, g/l	74
Moisture Content, ASTM D 4017, %	<0.01
Total Volatile Content, ASTM D 2369, %	3.0
Flash Point - See SDS	

## TYPICAL CURING PERFORMANCE

### Recommended Curing Conditions

- 10 minutes @ 125°C
- 6 minutes @ 150°C
- 3 minutes @ 175 °C

Sufficient time must be added to allow the bond location to reach the desired cure temperature. Alternate cure profiles may be evaluated.

The above cure profile is a guideline recommendation. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

## TYPICAL PROPERTIES OF CURED MATERIAL

### Physical Properties

Coefficient of Thermal Expansion, ISO 11359-2, K <sup>-1</sup> :	
Pre Tg	45
Post Tg	220

Glass Transition Temperature, ISO 11359-2, °C: (Tg) by TMA	40
Water Absorption, ISO 62, %:	
2 hours in boiling water:	
Increased weight	<5
Soluble matter loss	<1
Water absorbed	<5
24 hours in water @ 22 °C:	
Increased weight	<1
Soluble matter loss	<0.02
Water absorbed	<1
Coefficient of Thermal Conductivity ASTM F 433, W/(m·K)	>2
Extractable Ionic Content, µg/g:	
Chloride	<20
Potassium	<6
Sodium	<6
Fluorine	<6

Cured for 15 minutes @ 130 °C

### Electrical Properties

Volume Resistivity, IEC 60093, Ω·cm	<0.8×10 <sup>-3</sup> LMS
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Cured for 1 hour @ 130 °C

### Physical Properties

Volume Shrinkage, ASTM D 792, %	<3
Shore Hardness, ISO 868, Durometer D	78
Elongation, ISO 527-3, %	1.3
Tensile Strength, ISO 527-3	N/mm <sup>2</sup> 34.5 (psi) (5,000)
Tensile Modulus, ISO 527-3	N/mm <sup>2</sup> 3,100 (psi) (450,000)

## TYPICAL PERFORMANCE OF CURED MATERIAL

### Adhesive Properties

Cured for 15 minutes @ 130 °C

Lap Shear Strength, ISO 4587:

Epoxyglass :	
0.25 mm gap	N/mm <sup>2</sup> 2.0 (psi) (300)
Aluminum :	
0.25 mm gap	N/mm <sup>2</sup> 4.1 (psi) (600)
Glass :	
0.25 mm gap	N/mm <sup>2</sup> 2.0 (psi) (300)

Cured for 2 hours @ 130 °C

Lap Shear Strength, ISO 4587:

Aluminum (etched & abraded):	
0.127 mm gap	N/mm <sup>2</sup> ≥4.8 <sup>LMS</sup> (psi) (≥696)

**GENERAL INFORMATION**

**This product is not recommended for use in pure oxygen and/or oxygen rich systems and should not be selected as a sealant for chlorine or other strong oxidizing materials.**

**For safe handling information on this product, consult the Safety Data Sheet (SDS).**

**Directions for use:**

1. LOCTITE ABLESTIK 3880 is supplied de-aerated in a range of ready-to-use syringes which fit straight into a variety of air pressure/time dispensing systems commonly available.
2. After storage the adhesive must be allowed to equilibrate to room temperature before use, typically 24 hours. The product has a typical work life of 7 days if dispensed directly from the syringe package, and one shift (8 to 12 hours) if applied via stencil or screen print.
3. Avoid cross contamination with other epoxy or acrylic adhesives by ensuring dispense nozzels, adapters etc. are thoroughly cleaned.
4. Do not leave dirty nozzles on dispensing equipment while not in use or soaking in solvents for long periods of time.
5. The quantity of adhesive dispensed will depend on the dispense pressure, time, nozzle size and temperature.
6. These parameters will vary depending on the type of dispensing system used and should be optimised accordingly.
7. Dispensing temperature should ideally be controlled at a value between 30 °C to 35 °C for optimum results, however higher dispense temperatures are possible.
8. LOCTITE ABLESTIK 3880 can also be dispensed using positive displacement pump systems.
9. The product is not recommended for dispensing by pin transfer.
10. Uncured adhesive can be cleaned from the board with isopropanol, MEK or ester blends such as LOCTITE® 7360™.
11. When dispensing either directly from the syringe or through a positive displacement valve, system pressure should typically be between (0.1 and 0.3 MPa). The typical cycle time required to dispense through a 0.4 mm diameter tip ranges from 30 to 100 ms. Continuous extrusion of 0.5 mm diameter beads can be achieved at linear dispense rates of 5 to 50 mm/s (depending on the application).
12. Stencil or screen printing; down to 0.5 mm pitch and 0.25 mm site width can be achieved at speeds up to 25 mm/s (depending on the application).

**Loctite Material Specification<sup>LMS</sup>**

LMS dated January 15, 2001. Test reports for each batch are available for the indicated properties. LMS test reports include selected QC test parameters considered appropriate to specifications for customer use. Additionally, comprehensive controls are in place to assure product quality and consistency. Special customer specification requirements may be coordinated through Henkel Quality.

**Storage**

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

**Optimal Storage: 0 °C. Storage below or greater than 0 °C can adversely affect product properties.** Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

**Conversions**

(°C x 1.8) + 32 = °F  
 kV/mm x 25.4 = V/mil  
 mm / 25.4 = inches  
 µm / 25.4 = mil  
 N x 0.225 = lb  
 N/mm x 5.71 = lb/in  
 N/mm<sup>2</sup> x 145 = psi  
 MPa x 145 = psi  
 N·m x 8.851 = lb·in  
 N·m x 0.738 = lb·ft  
 N·mm x 0.142 = oz·in  
 mPa·s = cP

**Note:**

The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the date of this TDS. The product can have a variety of different applications as well as differing application and working conditions in your environment that are beyond our control. Henkel is, therefore, not liable for the suitability of our product for the production processes and conditions in respect of which you use them, as well as the intended applications and results. We strongly recommend that you carry out your own prior trials to confirm such suitability of our product. Any liability in respect of the information in the Technical Data Sheet or any other written or oral recommendation(s) regarding the concerned product is excluded, except if otherwise explicitly agreed and except in relation to death or personal injury caused by our negligence and any liability under any applicable mandatory product liability law.

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Reference **N/A**